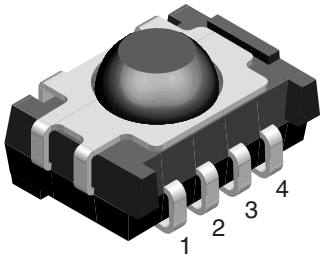
IR Mid Range Proximity Sensor



16797

FEATURES

- Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- 940 nm peak wavelength
- Photo detector and preamplifier in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Pb-free

e3

RoHS COMPLIANT

HALOGEN FREE GREEN (5-2008)

MECHANICAL DATA

Pinning

1 = GND, 2 = N.C., 3 = V_S, 4 = OUT

ORDERING CODE

Taping:

TSSP6P38TT - top view taped

TSSP6P38TR - side view taped

DESCRIPTION

The TSSP6P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

APPLICATIONS

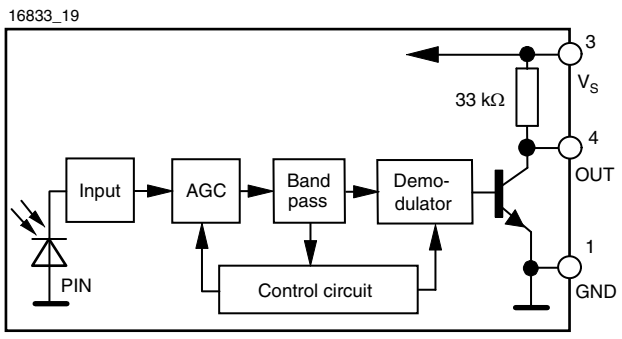
- Safety switches for garage door, elevator door, gates, and industrial light curtains
- Reflective sensors for toilet, urinal, faucet and hand dryer, and towel dispenser
- Navigational sensor for robotics
- Sensor for large format touch panels
- Object detection in vending machines, parking lots, ATM's, and many others

PARTS TABLE		
Carrier frequency	38 kHz	TSSP6P38
Package		Panhead
Pinning		1 = GND, 2 = N.C., 3 = V_S, 4 = OUT
Dimensions (mm)		7.5 W x 5.3 H x 4.0 D
Mounting		SMD
Application		Proximity sensors

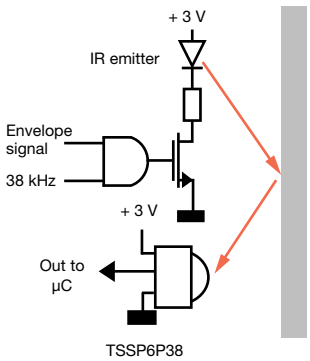
Note

- Other frequencies available by request

BLOCK DIAGRAM



PROXIMITY SENSING



ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage (pin 3)		V_S	-0.3 to +6	V
Supply current (pin 3)		I_S	5	mA
Output voltage (pin 4)		V_O	-0.3 to 5.5	V
Voltage at output to supply		$V_S - V_O$	-0.3 to (V_S + 0.3)	V
Output current (pin 4)		I_O	5	mA
Junction temperature		T_j	100	°C
Storage temperature range		T_{stg}	-25 to +85	°C
Operating temperature range		T_{amb}	-25 to +85	°C
Power consumption	$T_{amb} \leq 85$ °C	P_{tot}	10	mW

Note

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating condtions for extended periods may affect the device reliability.

ELECTRICAL AND OPTICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	E_e = 0, V_S = 5 V	I_{SD}	0.55	0.7	0.9	mA
	E_v = 40 klx, sunlight	I_{SH}		0.8		mA
Supply voltage		V_S	2.7		5.5	V
Receiving distance	Direct line of sight, test signal see fig. 1, IR diode TSAL6200, I_F = 200 mA	d		40		m
Output voltage low (pin 4)	I_{OSL} = 0.5 mA, E_e = 0.7 mW/m², test signal see fig. 1	V_{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see fig. 1	$E_{e\ min.}$		0.2	0.4	mW/m²
Maximum irradiance	$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see fig. 1	$E_{e\ max.}$	50			W/m²
Directivity	Angle of half receiving distance	$\varphi_{1/2}$		± 45		deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

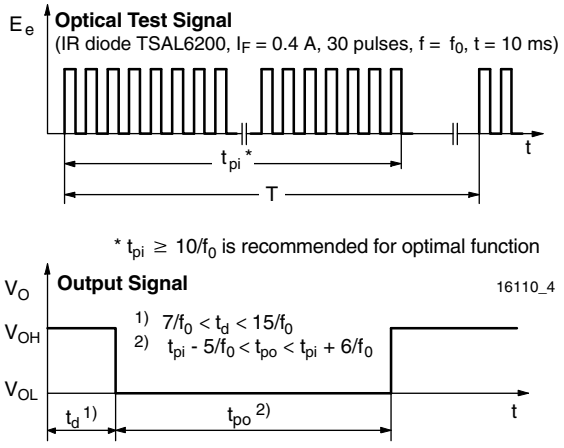


Fig. 1 - Output Active Low

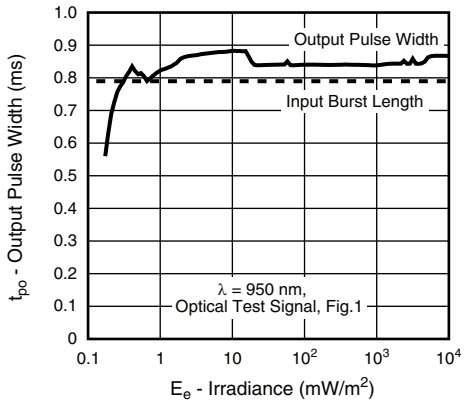


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

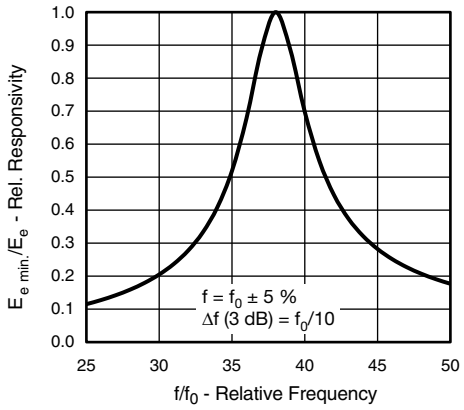


Fig. 3 - Frequency Dependence of Responsivity

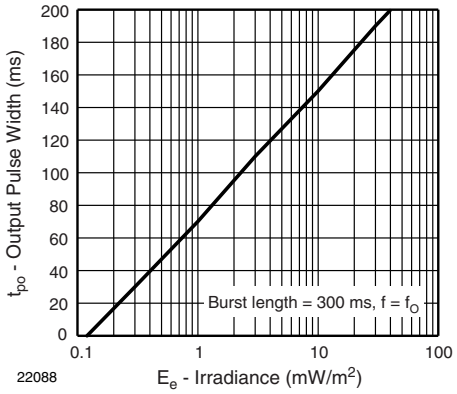


Fig. 6 - Maximum Output Pulse Width vs. Irradiance

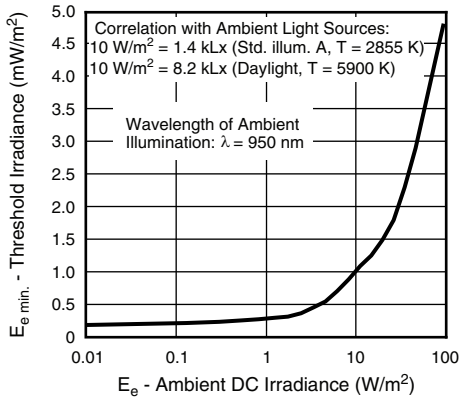


Fig. 4 - Sensitivity in Bright Ambient

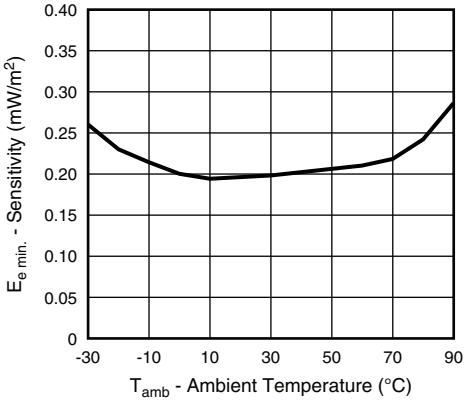


Fig. 7 - Sensitivity vs. Ambient Temperature

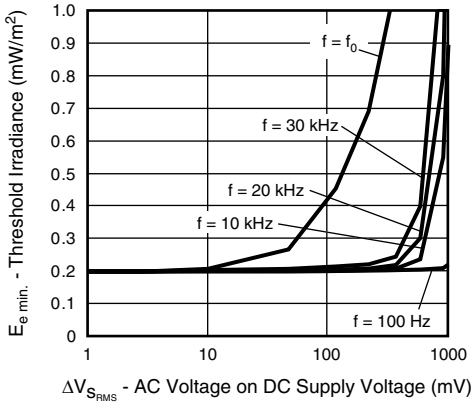


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

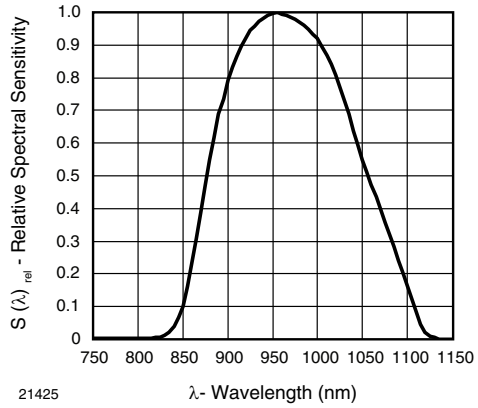


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

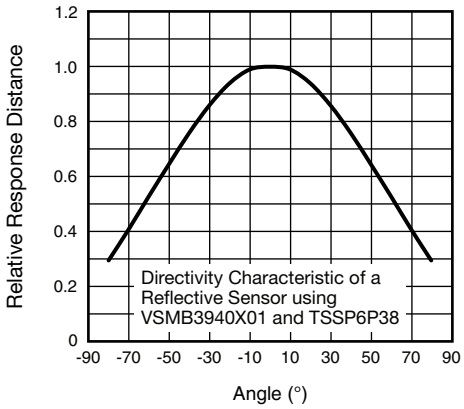


Fig. 9 - Angle Characteristic

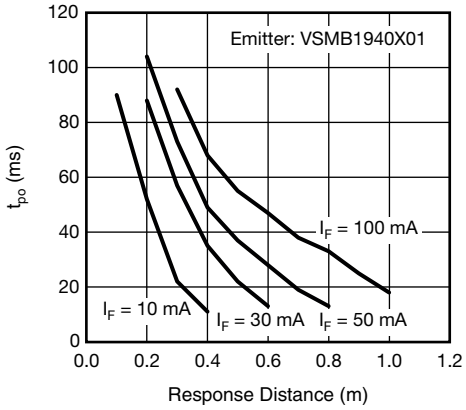


Fig. 11 - t_{po} vs. Distance Kodak Gray Card Plus 15 %

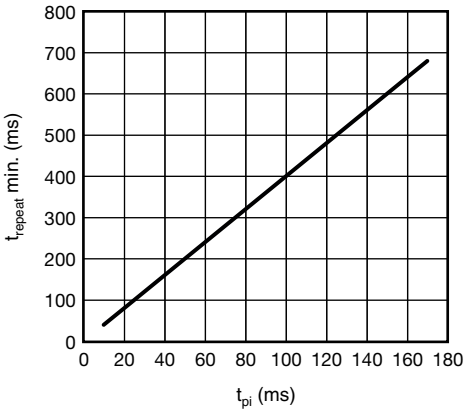


Fig. 10 - Max. Rate of Bursts

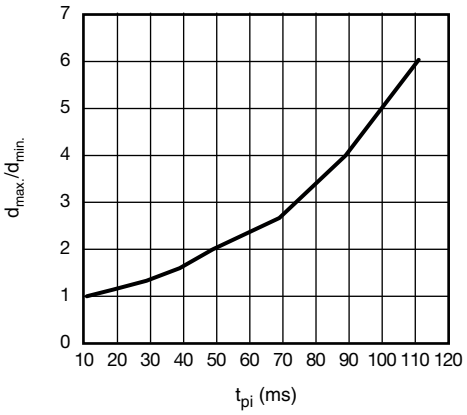
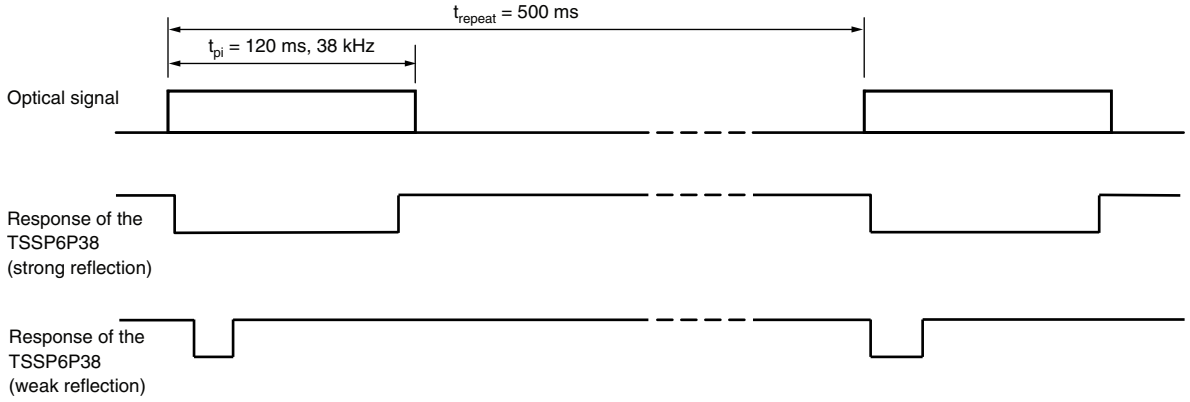


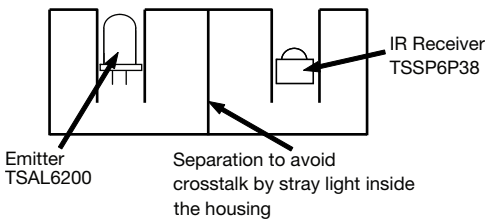
Fig. 12 - Dynamic Range of Sensor vs. t_{pi}

The typical application of the TSSP6P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:



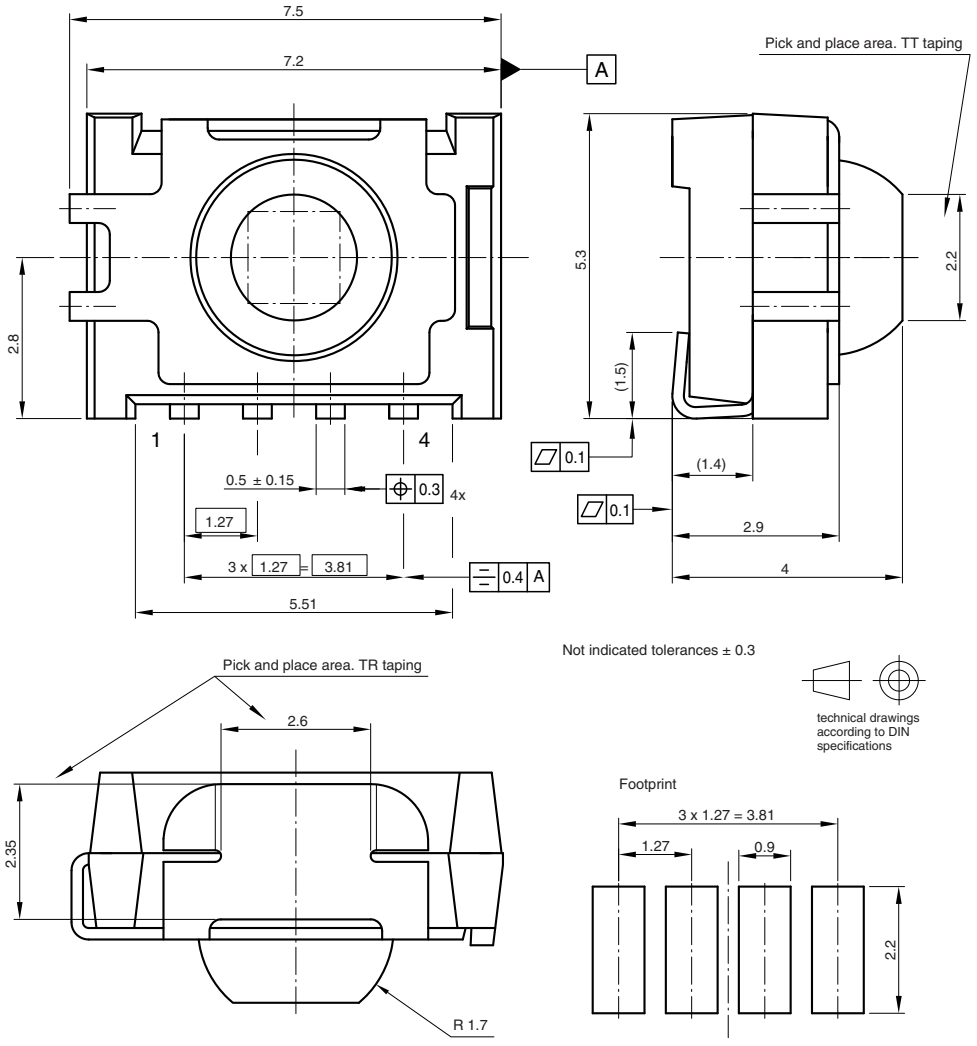
Example for a sensor hardware:



There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP6P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.

PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4
Issue: 8; 02.09.09
16776

ASSEMBLY INSTRUCTIONS

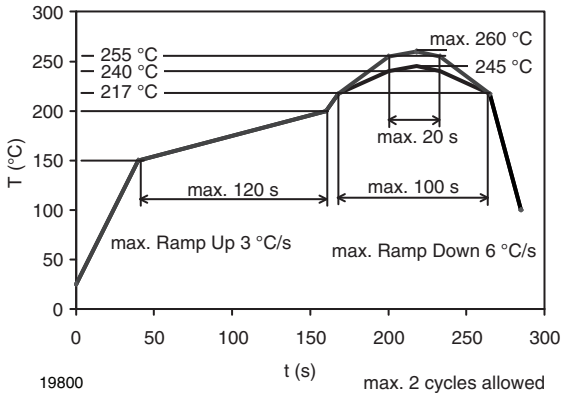
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

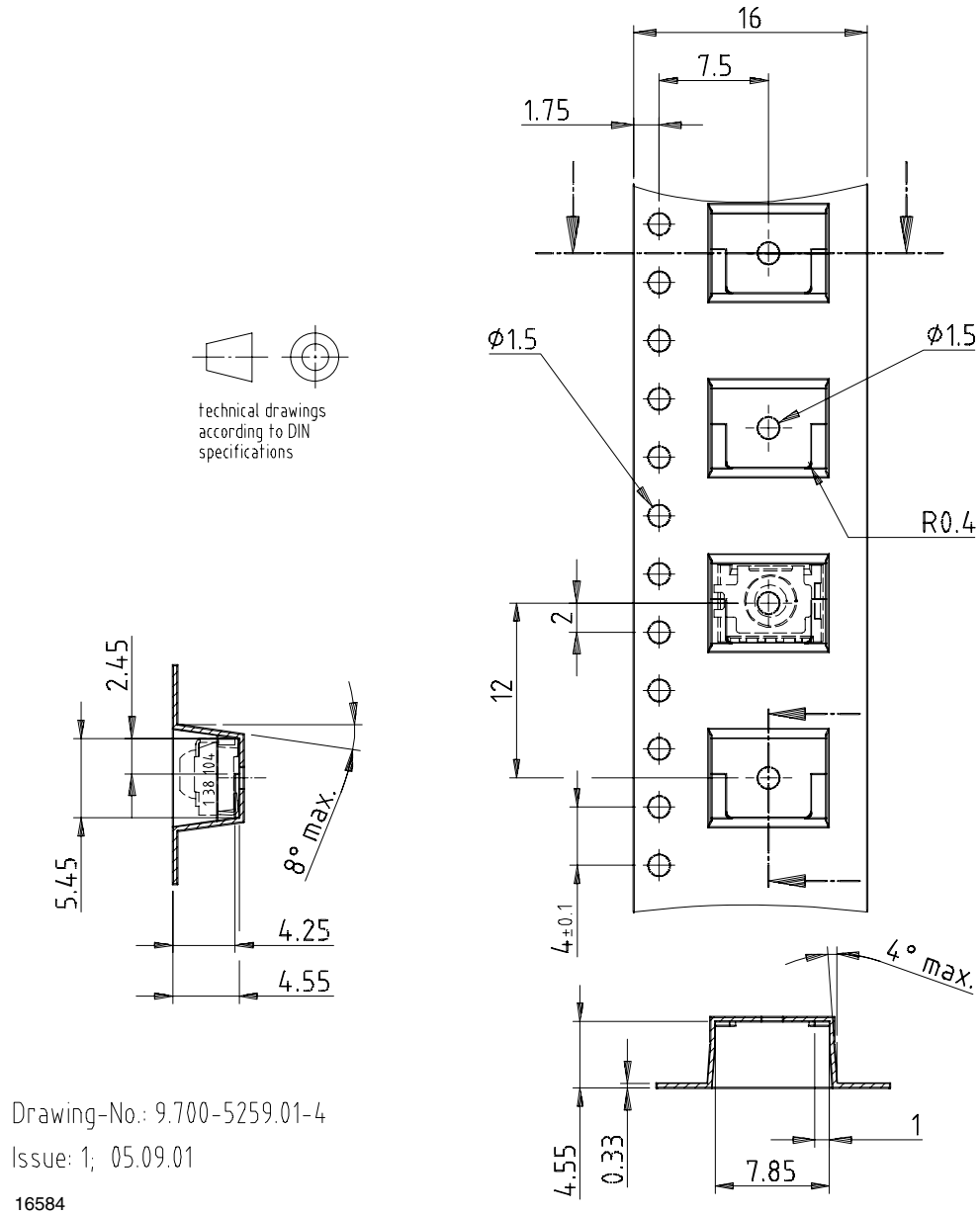
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

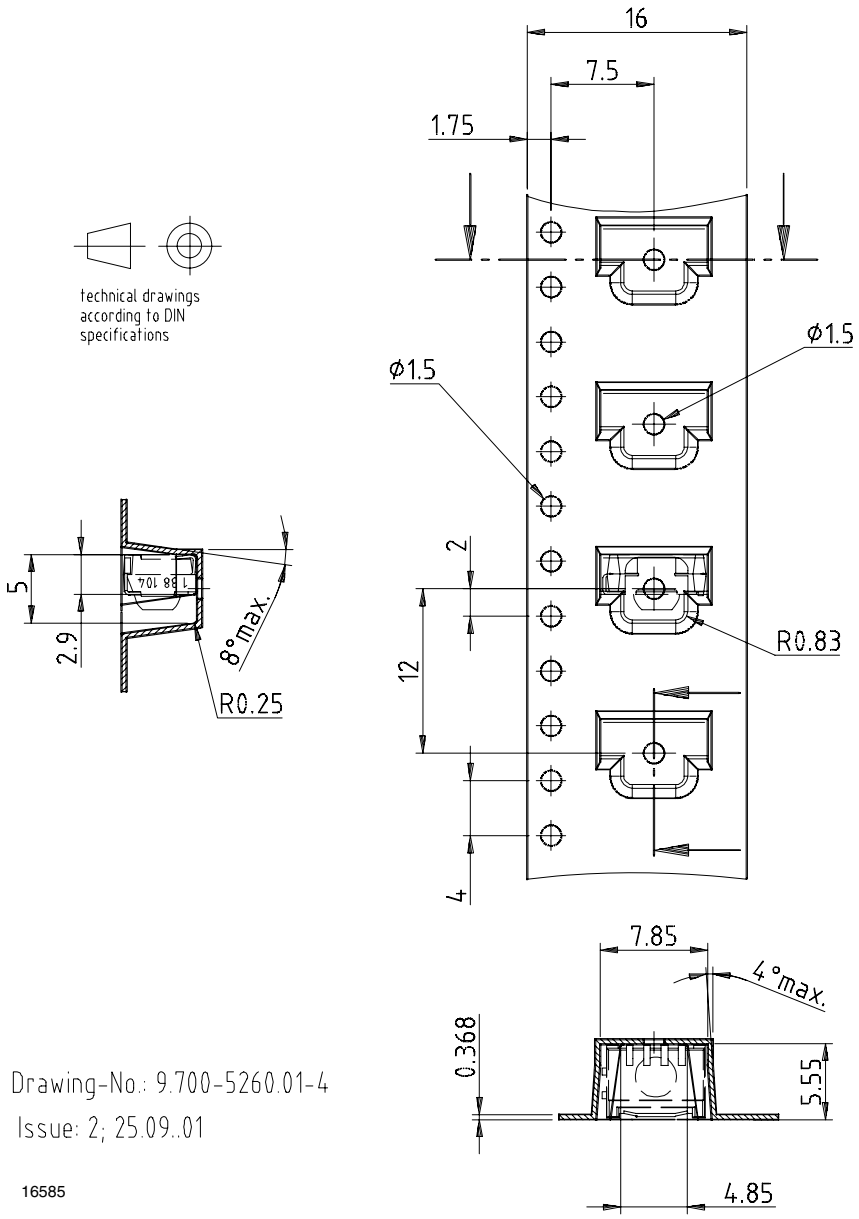


TAPING VERSION TSSP..TT DIMENSIONS in millimeters

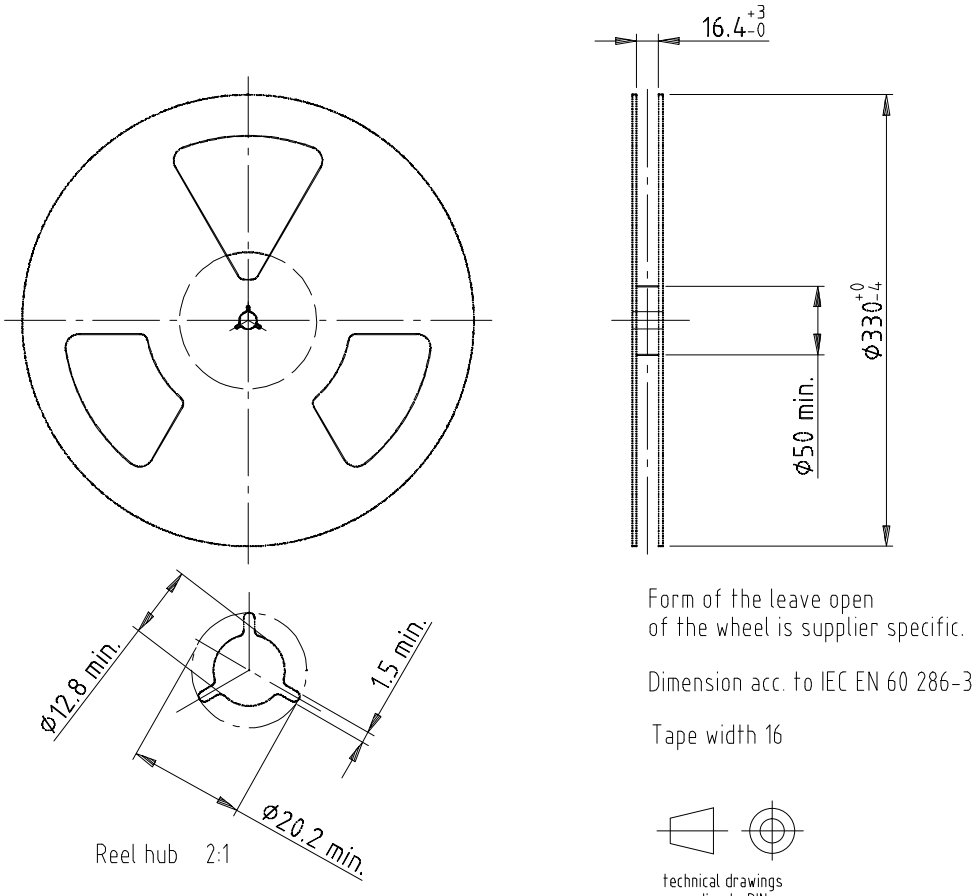


Drawing-No.: 9.700-5259.01-4
Issue: 1; 05.09.01
16584

TAPING VERSION TSSP..TR DIMENSIONS in millimeters



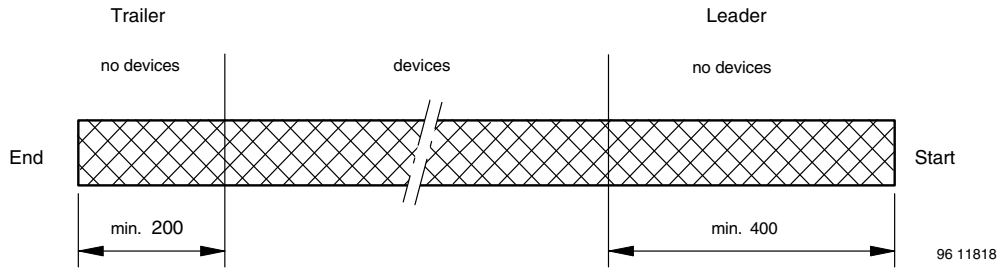
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4
Issue: 1; 07.05.02

16734

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3
0.1 N to 1.3 N
300 mm/min. ± 10 mm/min.
165° to 180° peel angle

LABEL

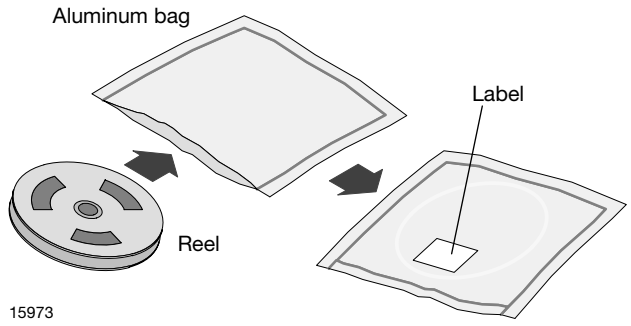
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (Finished goods)		
PLAIN WRITING	**ABBREVIATION**	**LENGTH**
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	**TYPE**	**LENGTH**
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	**TYPE**	**LENGTH**
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

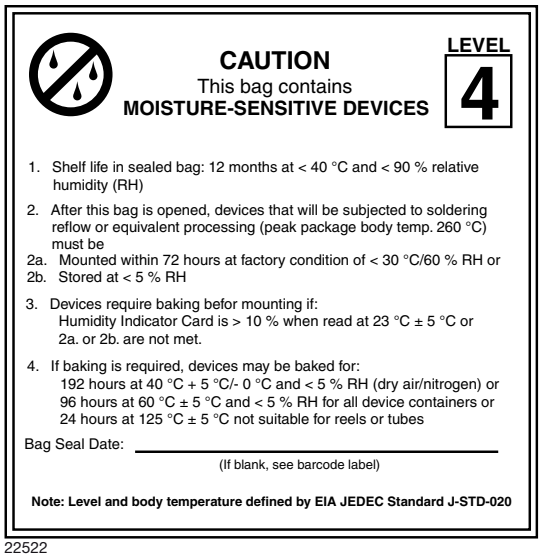
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen)
or
96 h at 60 °C + 5 °C and < 5 % RH for all device containers
or
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



22522

EIA JEDEC standard J-STD-020 level 4 label
is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

22645

Tape and Reel Standards for SMD IR Receiver Modules

Vishay Semiconductor SMD IR Receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

A. Panhead SMD: quantity per reel:

TT, SMD top view package, 1190 pcs

TR, SMD side view package, 1120 pcs

B. Heimdall: quantity per reel:

TT, Heimdall top view package, 2200 pcs

TR, Heimdall side view package, 2300 pcs

C. Heimdall without lens: quantity per reel:

WTT, top view package, 2200 pcs

WTR, side view package, 2300 pcs

D. Bugeye: quantity per reel:

TT, 2500 pcs

TR, 2500 pcs

E. AP5: quantity per reel:

TT, 2500 pcs

TR, not available in side view

F. Belobog: quantity per reel:

TT1, 1800 pcs

TT2, 7000 pcs

TR, not available in side view

G. Belobog with shield: quantity per reel:

TT1, 1500 pcs

TT2, 5000 pcs

ORDER DESIGNATION

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

TSOP6238TR (reel packing)

TSOP75238TR (reel packing)

TSOP75338WTT (reel packing)

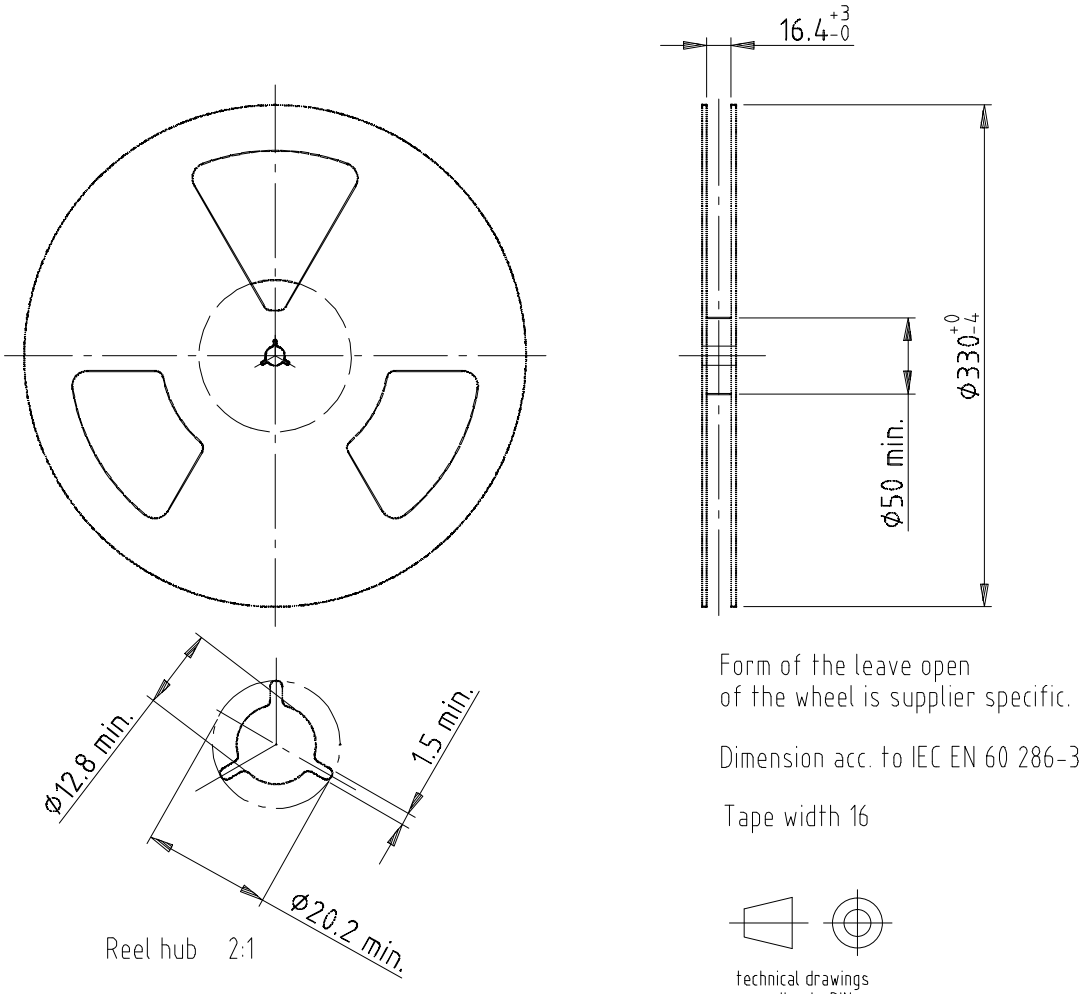
TSOP85438TT (reel packing)

TSOP85238AP5TR (reel packing)

TSOP57438TT1 (reel packing)

TSOP57238HTT1 (reel packing)

REEL DIMENSIONS FOR PANHEAD SMD AND HEIMDALL in millimeters

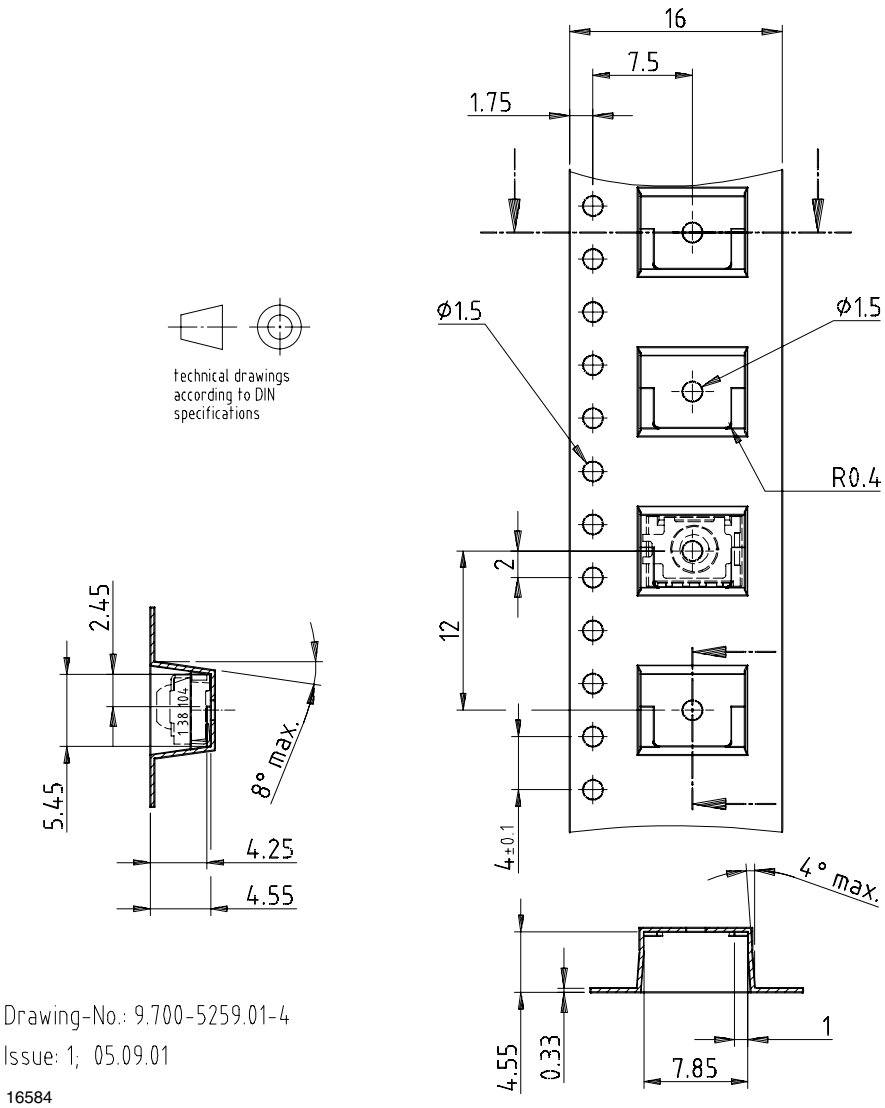


Note

- The body structure of the reel can vary

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TT, TSOP35...TT, TSOP6...TT)



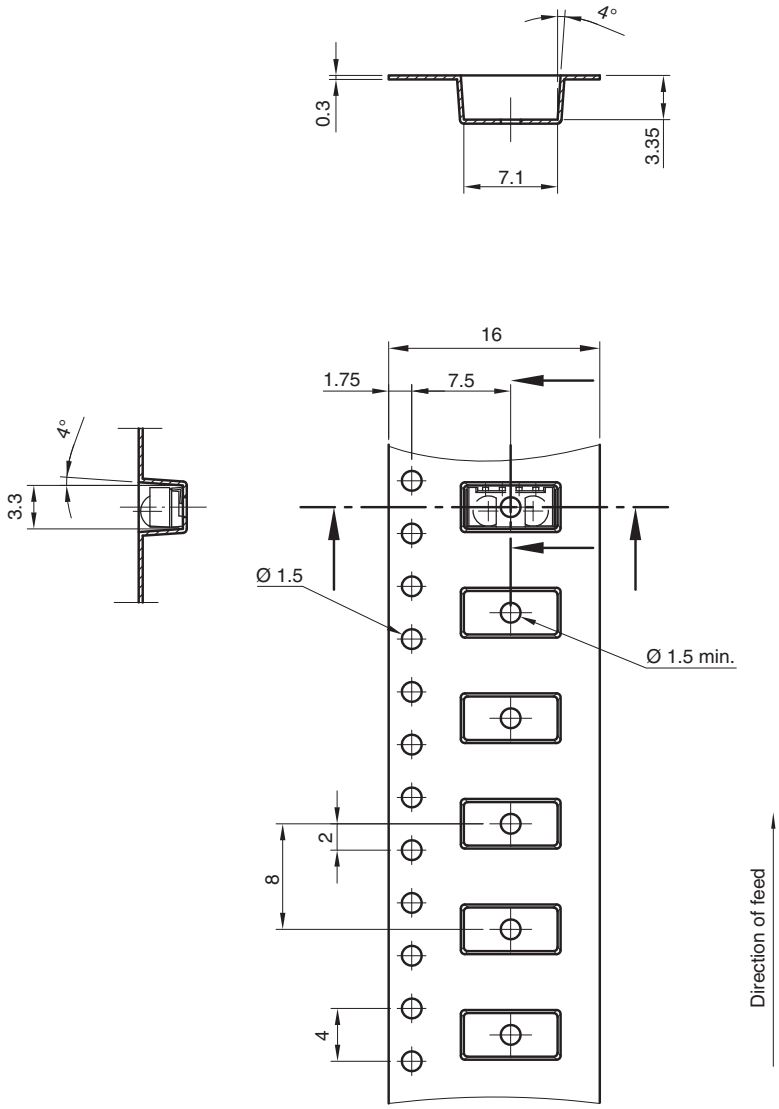
Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

16584

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75...TT, TSOP77...TT)

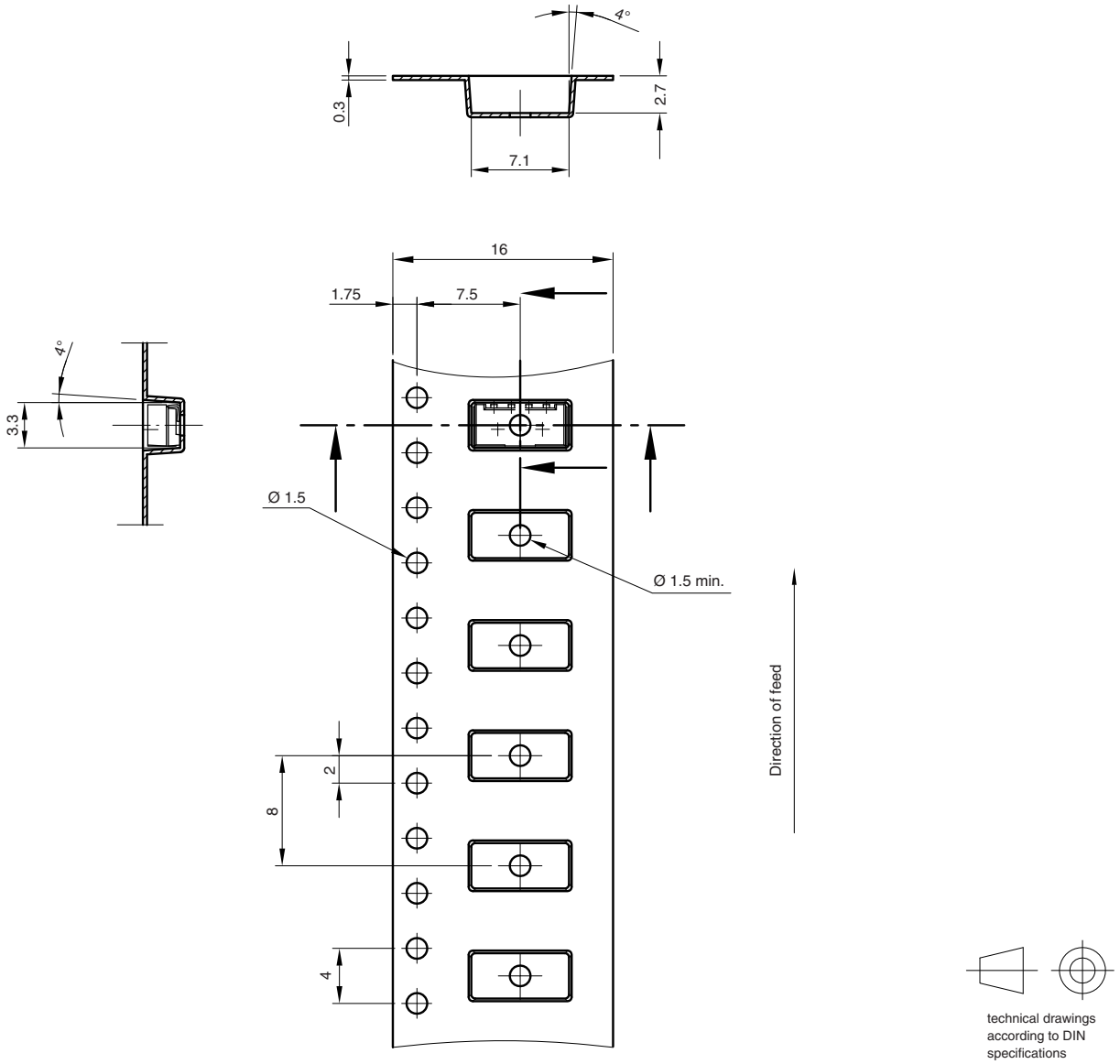


technical drawings
according to DIN
specifications

Drawing-No.: 9.700-5338.01-4
Issue: 3; 09.06.09
21578

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTT, TSOP77...WTT)



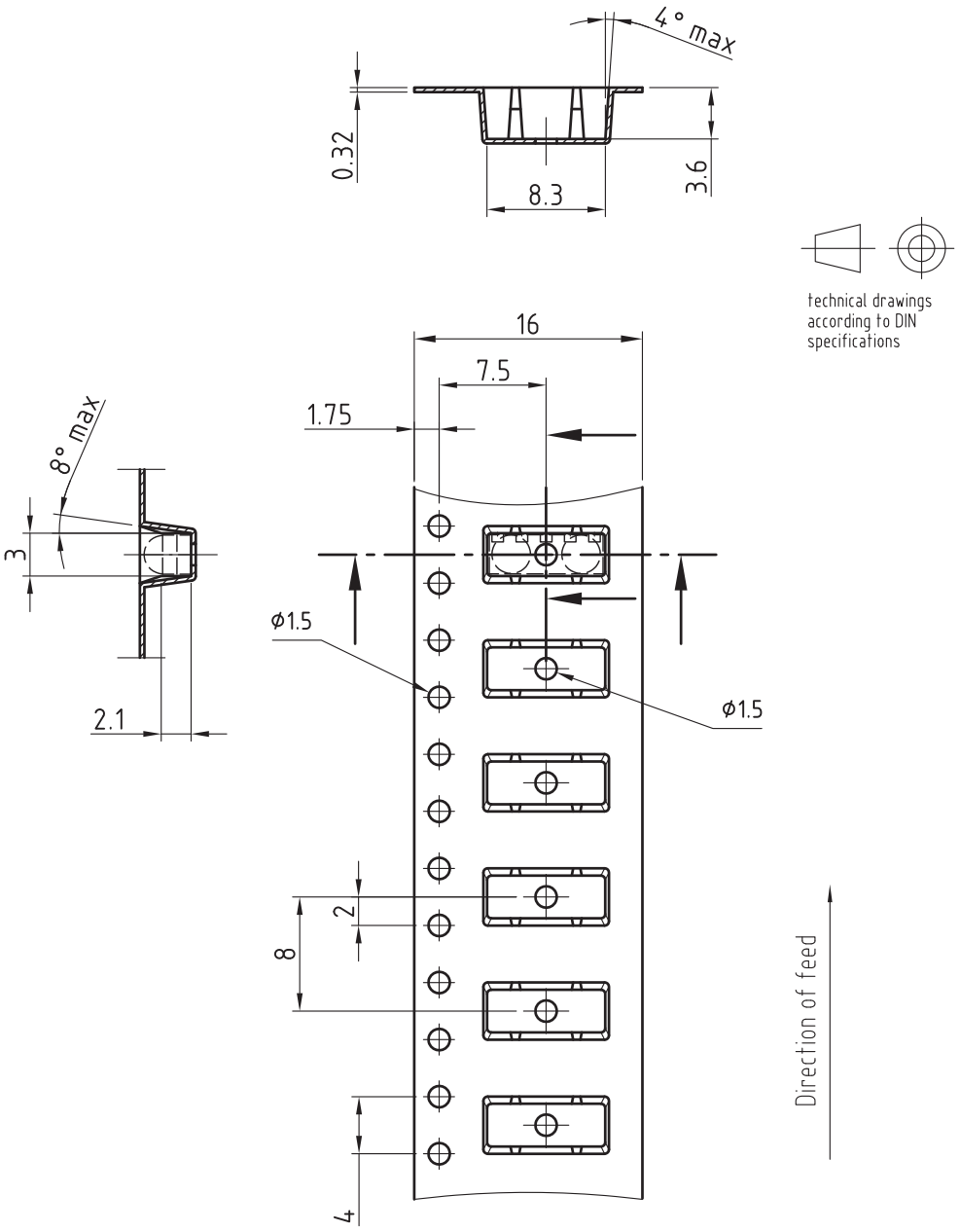
Drawing-No.: 9.700-5341.01-4

Issue: 2: 23.03.09

21666

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TT)



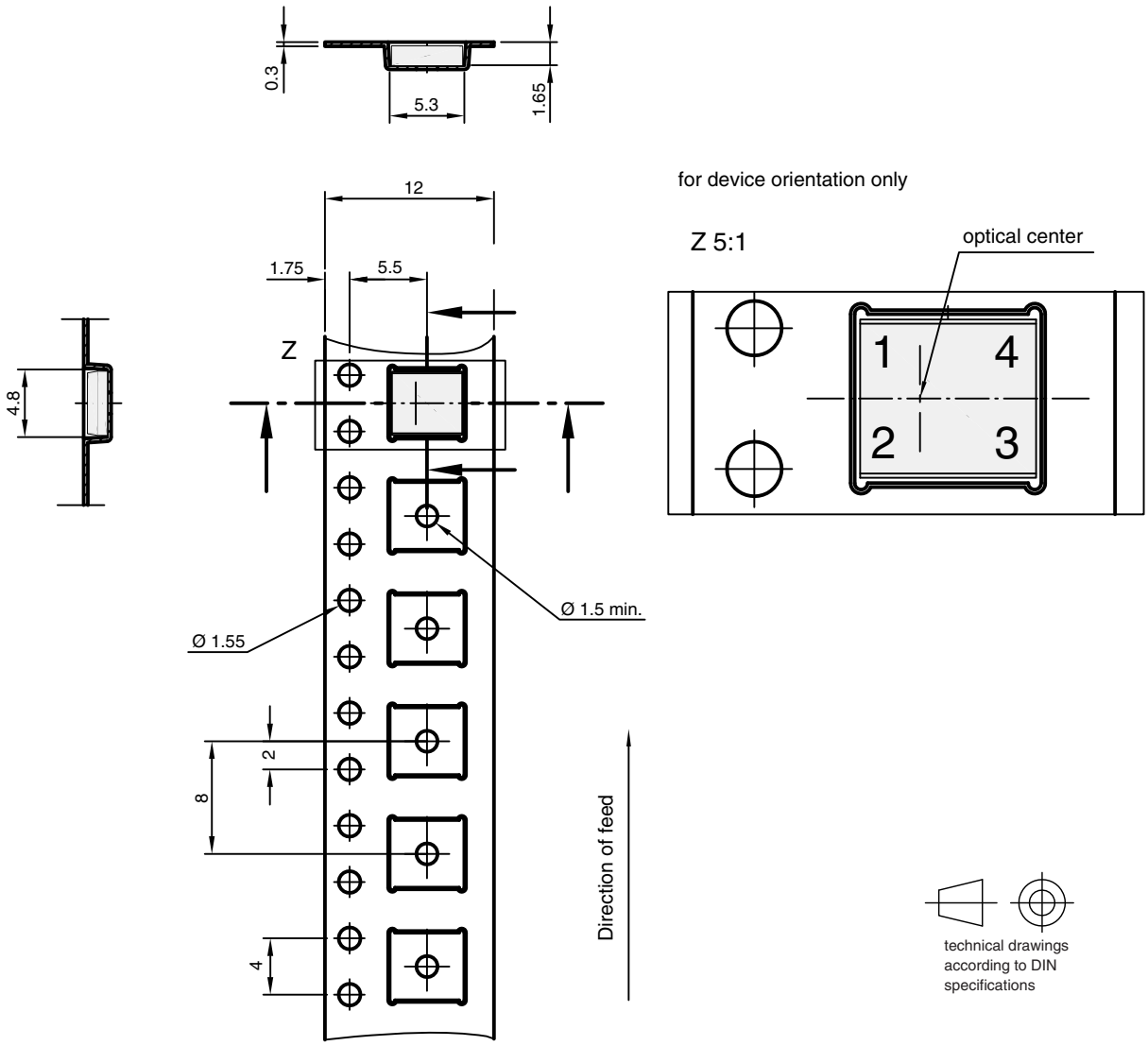
Drawing-No.: 9.700-5317.01-4

Issue: 2; 10.04.08

20629

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

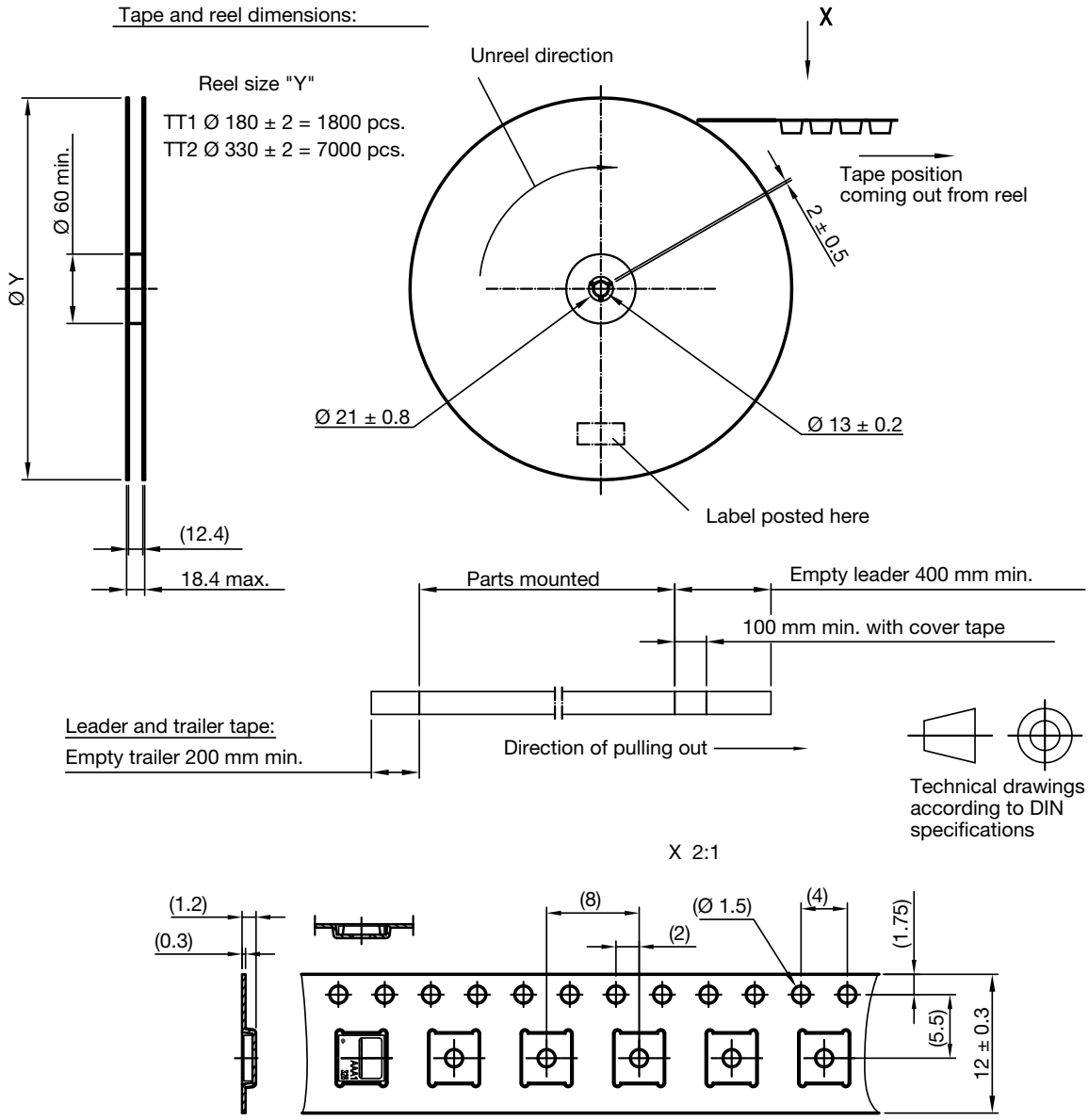
E. AP5 (TSOP85...AP5TT)



Drawing-No.: 9.700-5346.01-4
Issue: 2, 24.11.09
21945

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

F. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



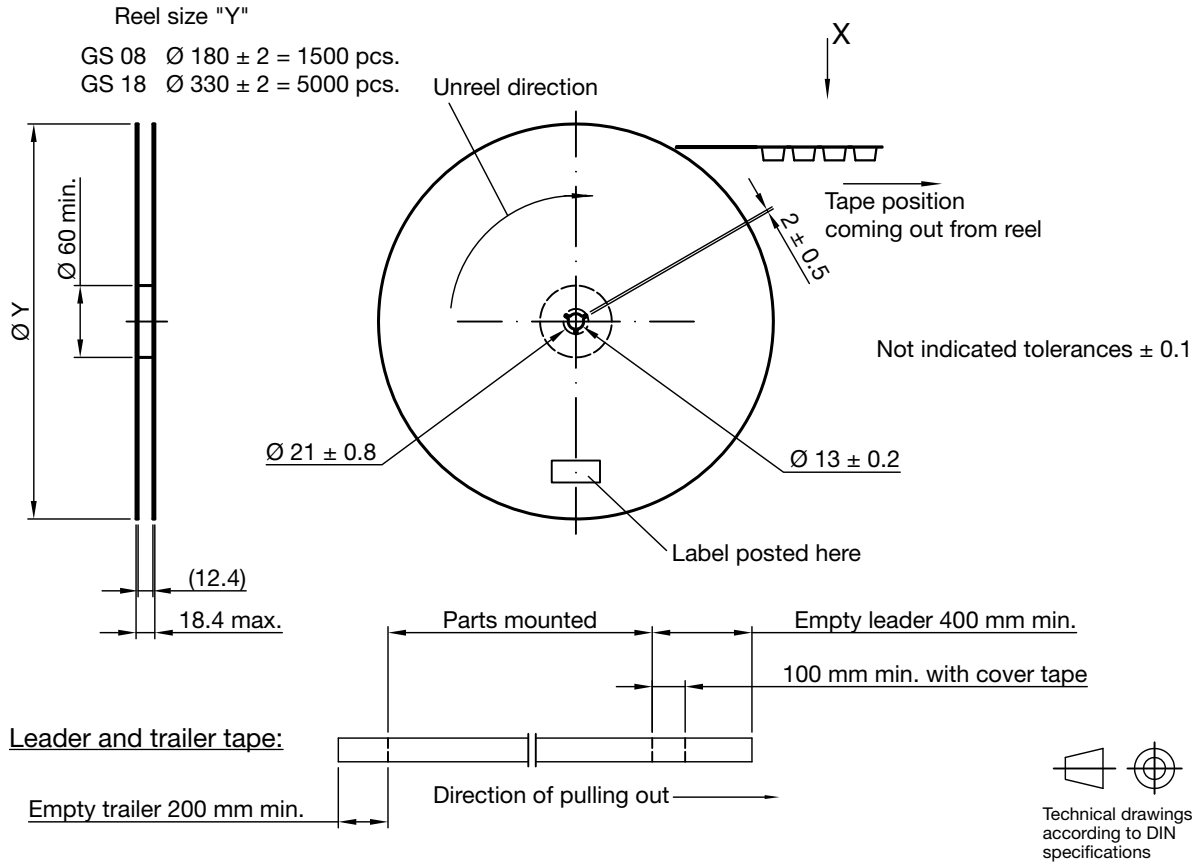
Drawing-No.: 9.700-5347.01-4
Issue: 1; 14.11.11

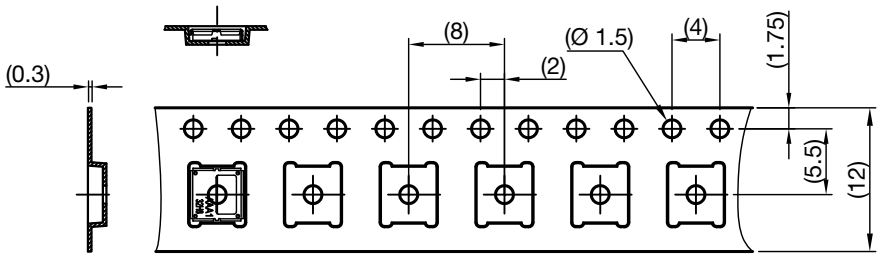
Not indicated tolerances ± 0.1

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

G. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:



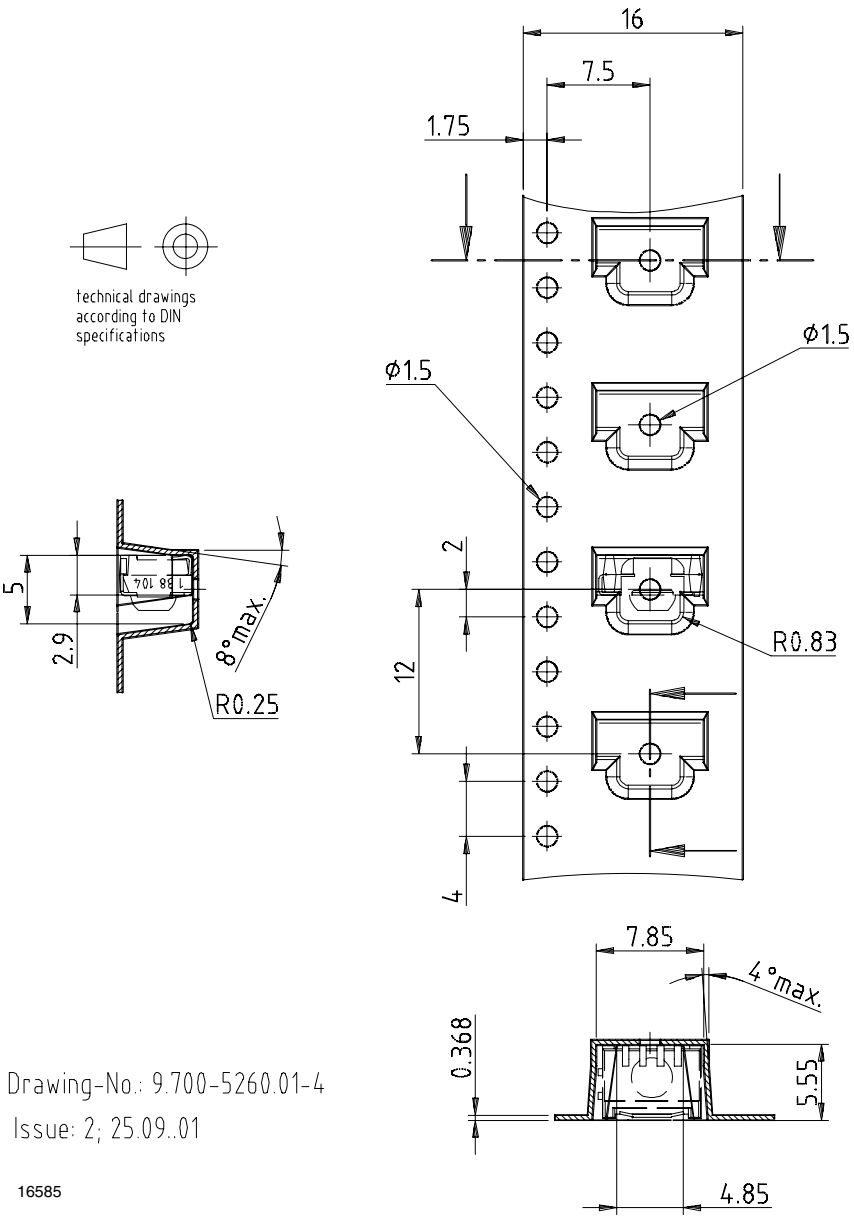


Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4
Issue: 1; 28.10.13

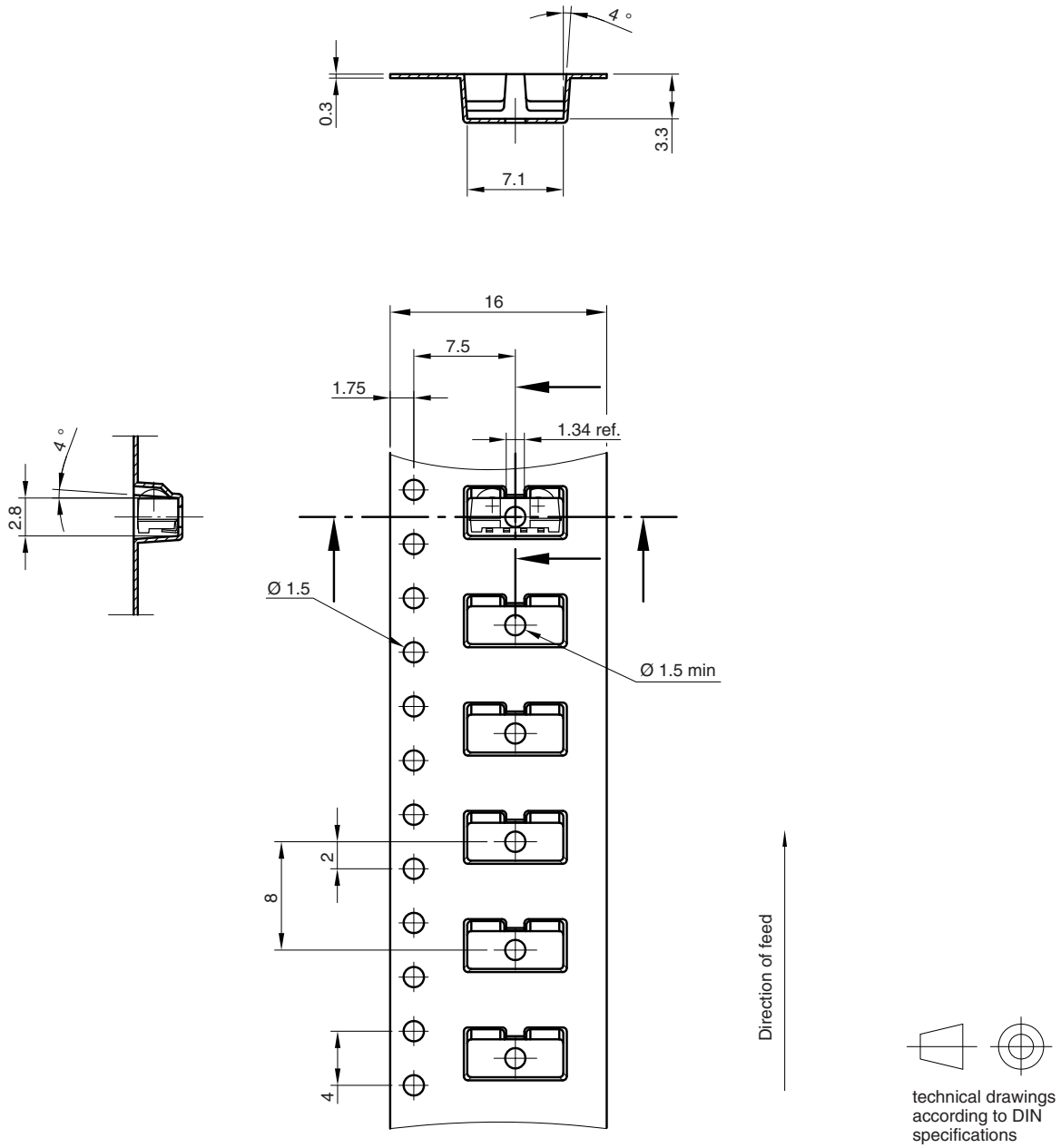
TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TR, TSOP35...TR, TSOP6...TR)



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75..., TSOP77...)



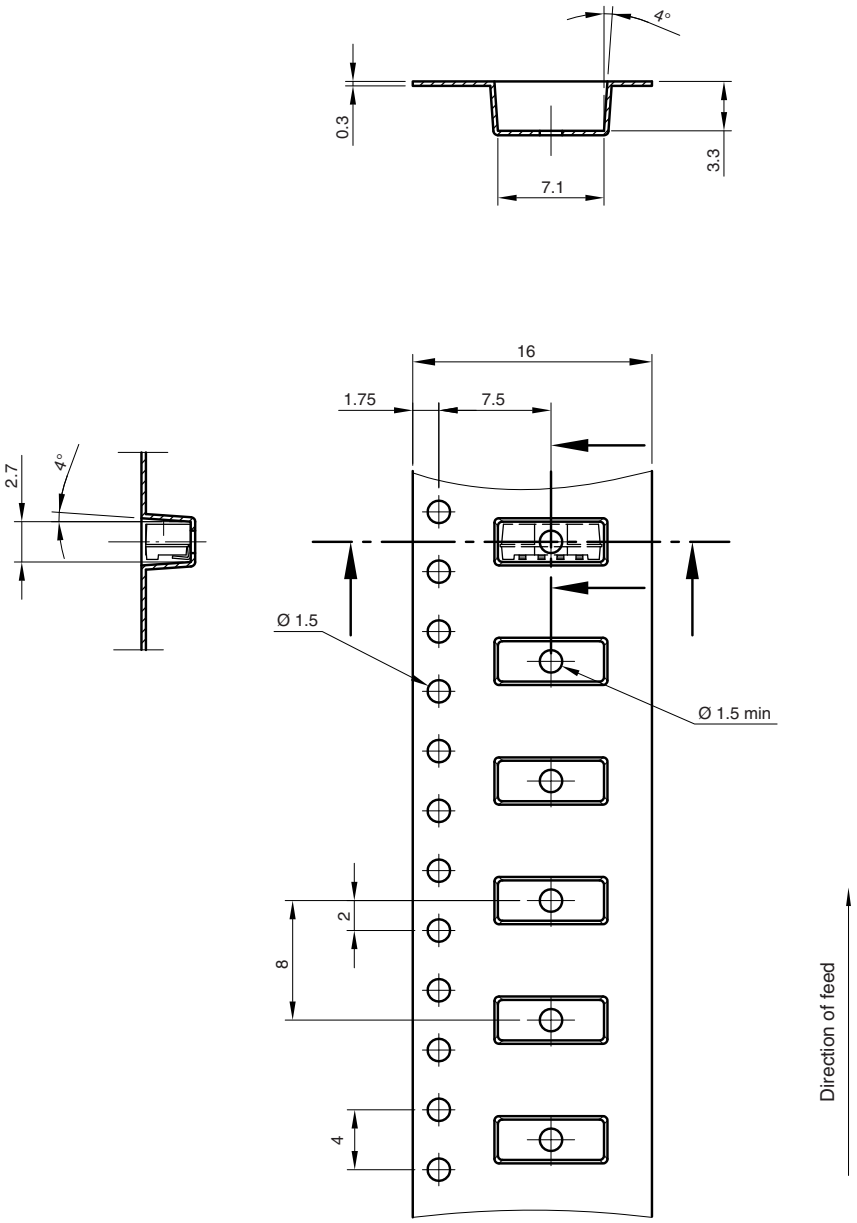
Drawing-No.: 9.700-5337.01-4

Issue: 1; 16.10.08

21577

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTR, TSOP77...WTR)

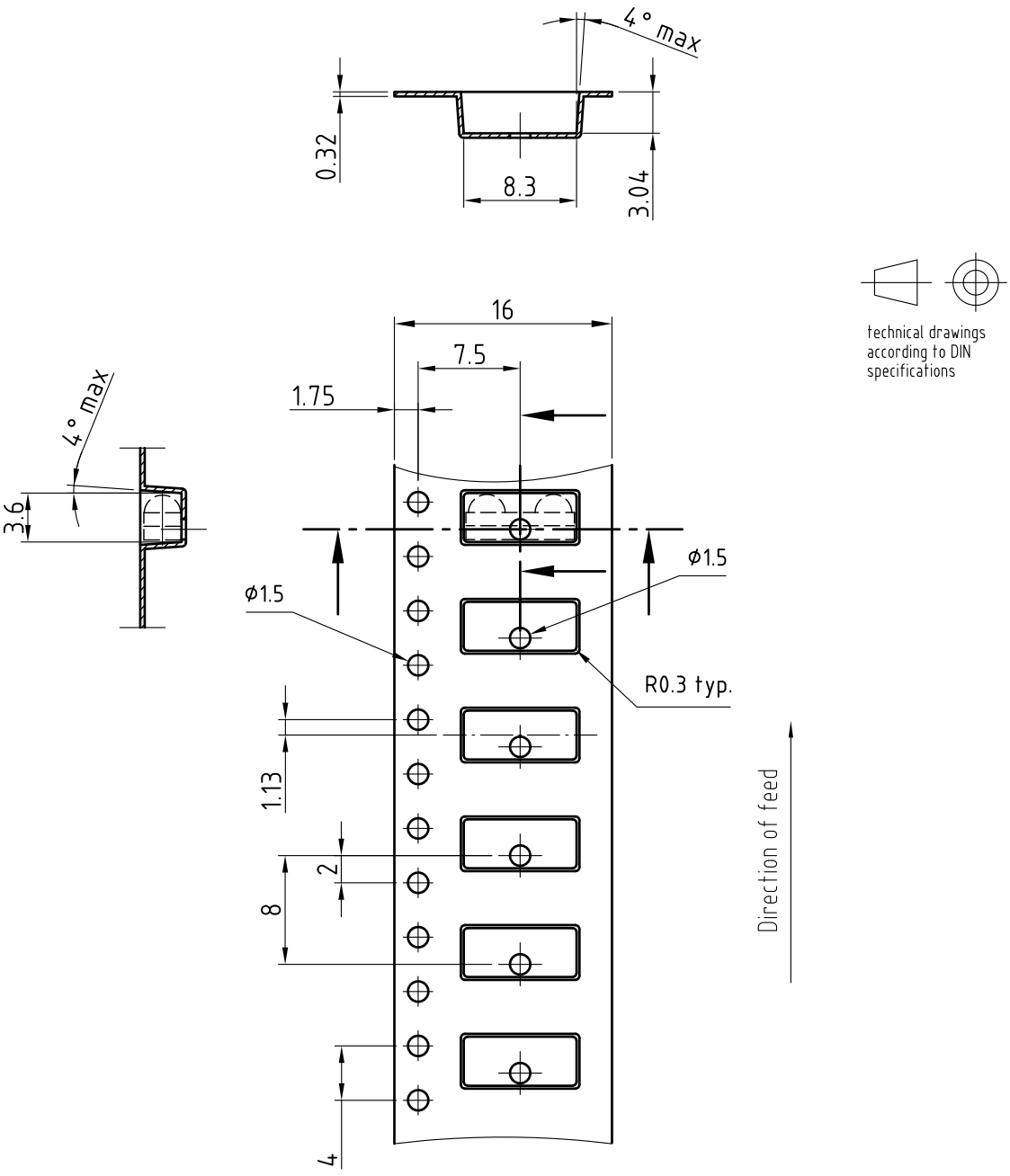


Drawing-No.: 9.700-5342.01-4
Issue: 1: 23.03.09
21785

technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TR)

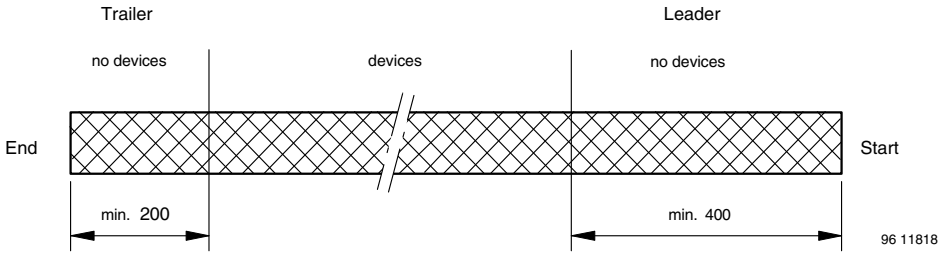


Drawing-No.: 9.700-5316.01-4

Issue: 1; 12.02.07

20628

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min. ± 10 mm/min.

165° to 180° peel angle

LABEL

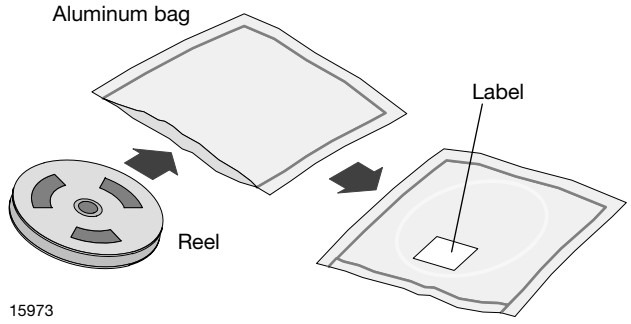
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	**ABBREVIATION**	**LENGTH**
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	**TYPE**	**LENGTH**
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE TOP	**TYPE**	**LENGTH**
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

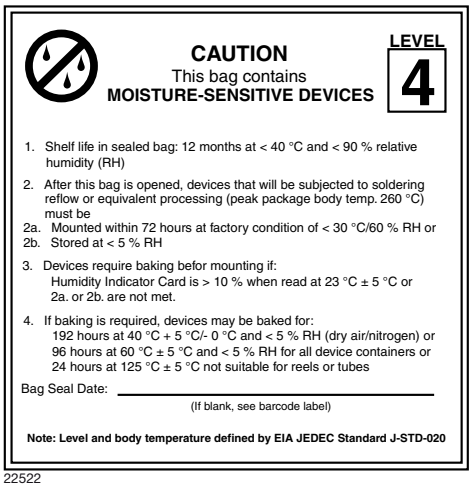
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen)
or
96 h at 60 °C + 5 °C and < 5 % RH for all device containers
or
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.



22522

EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

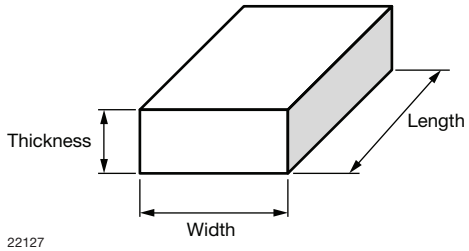
The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

16962

OUTER PACKAGING

The sealed reel is packed into a pizza box.

CARTON BOX DIMENSIONS in millimeters



22127

	THICKNESS	WIDTH	LENGTH
Pizza Box (SMD and Heimdall) (Taping in Reels)	50	340	340

Disclaimer

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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

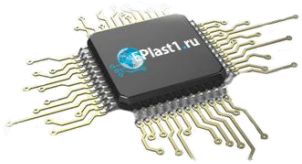
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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